



SHENZHEN TUOFENG SEMICONDUCTOR TECHNOLOGY CO.,LTD

# SOT-23 Plastic-Encapsulate MOSFETS

TF2319

## TF2319 P-Channel 40-V(D-S) MOSFET

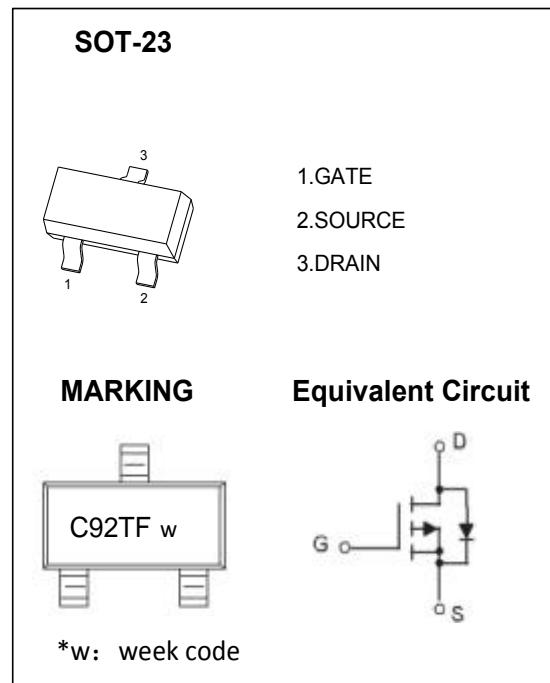
PRODUCT SUMMARY		
V <sub>DS</sub> (V)	r <sub>DSON(typ)</sub> (Ω)	I <sub>D</sub> (A)
- 40	0.065 at V <sub>GS</sub> = - 10 V	- 5.0
	0.085 at V <sub>GS</sub> = - 4.5 V	- 4.0

### General FEATURE

- TrenchFET Power MOSFET
- Lead free product is acquired
- Surface mount package

### APPLICATION

- Load Switch for Portable Devices
- DC/DC Converter



ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 40	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	I <sub>D</sub>	- 5.0	A	
Pulsed Drain Current	I <sub>DM</sub>	- 20		
Maximum Power Dissipation <sup>a, b</sup>	P <sub>D</sub>	1.25	W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	R <sub>thJA</sub>	75	100	°C/W
	Steady State		120	160	
Maximum Junction-to-Lead <sup>a</sup>	Steady State	R <sub>thJL</sub>	40	50	

Notes:

a. Surface Mounted on FR4 Board.

b. t ≤ 5 s.



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**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ	Max	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-40	-	-	V
Gate-Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	-1.0	-1.6	-2.5	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$	-	-	$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -36 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	-	-	-50	nA
On-State Drain Current <sup>a</sup>	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \leq -5 \text{ V}, V_{\text{GS}} = -10 \text{ V}$	-6	-	-	A
Drain-Source On-Resistance <sup>a</sup>	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10 \text{ V}, I_D = -5.0 \text{ A}$	-	0.065	0.082	$\Omega$
		$V_{\text{GS}} = -4.5 \text{ V}, I_D = -4.0 \text{ A}$	-	0.84	0.100	
Forward Transconductance <sup>a</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = -5 \text{ V}, I_D = -5.0 \text{ A}$	-	7.0	-	s
Diode Forward Voltage	$V_{\text{SD}}$	$I_S = -2.0 \text{ A}, V_{\text{GS}} = 0 \text{ V}$	-	-0.8	-1.20	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{\text{DS}} = -20 \text{ V}, V_{\text{GS}} = -10 \text{ V}$ $I_D \approx -5 \text{ A}$	-	11.8	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	2.2	-	
Gate-Drain Charge	$Q_{\text{gd}}$		-	3.0	-	
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -20 \text{ V}, V_{\text{GS}} = 0, f = 1 \text{ MHz}$	-	553	-	pF
Output Capacitance	$C_{\text{oss}}$		-	50	-	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	42	-	
<b>Switching<sup>c</sup></b>						
Turn-On Time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = -20 \text{ V}, V_{\text{GS}} = -10 \text{ V}$ $R_L = 2.5 \Omega, R_G = 3 \Omega$	-	7	-	ns
	$t_r$		-	6.5	-	
Turn-Off Time	$t_{\text{d}(\text{off})}$		-	24	-	
	$t_f$		-	7.8	-	

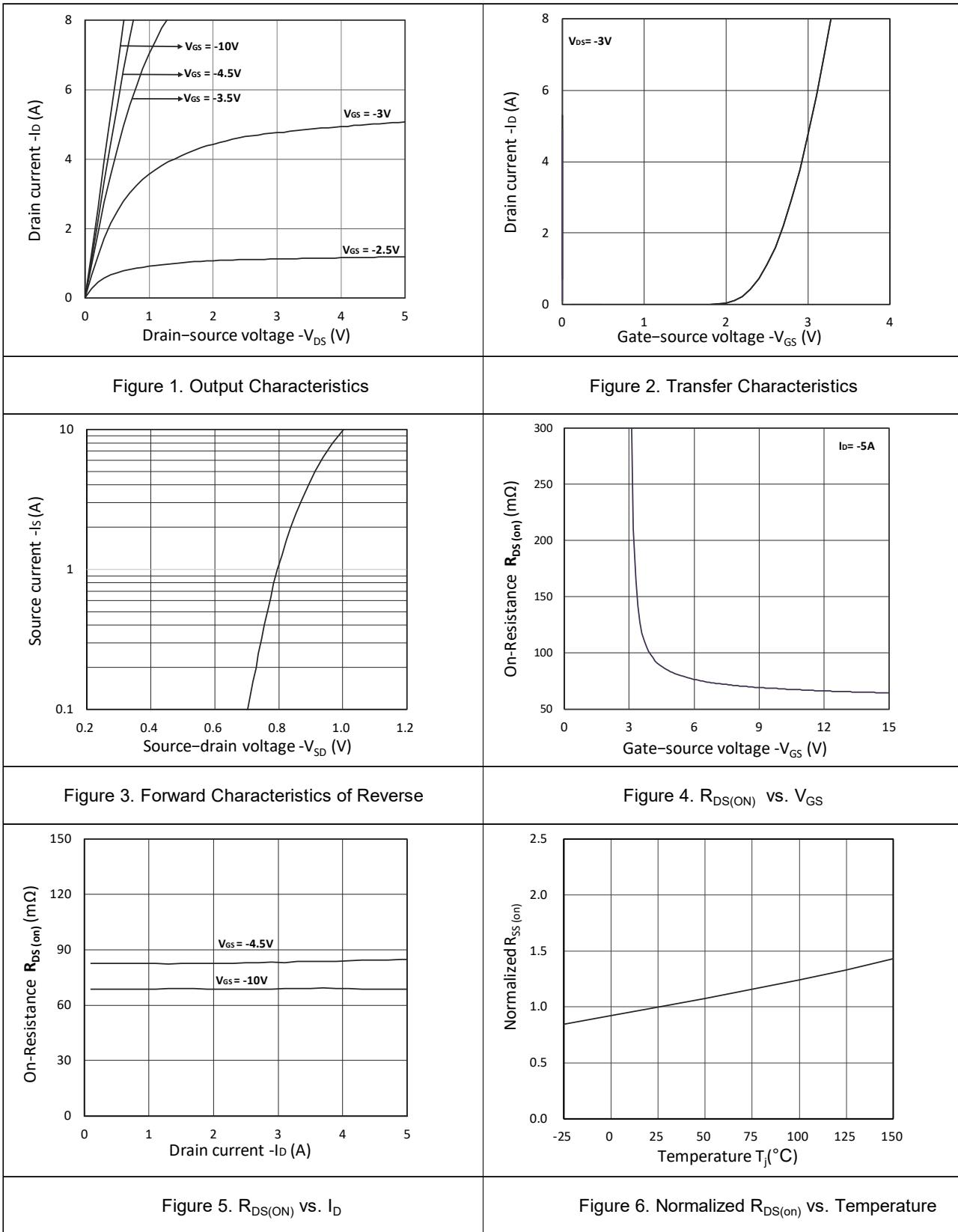
## Notes

- a. Pulse test:  $PW \leq 300 \mu\text{s}$  duty cycle  $\leq 2\%$ .
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

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## Typical Characteristics





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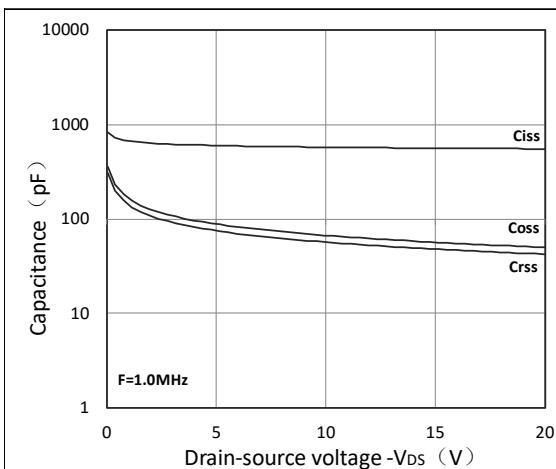


Figure 7. Capacitance Characteristics

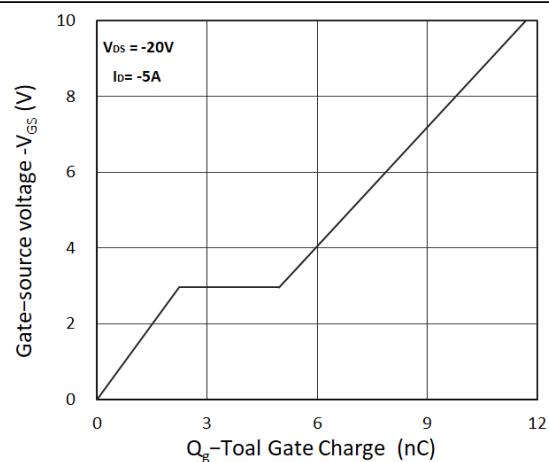


Figure 8. Gate Charge Characteristics

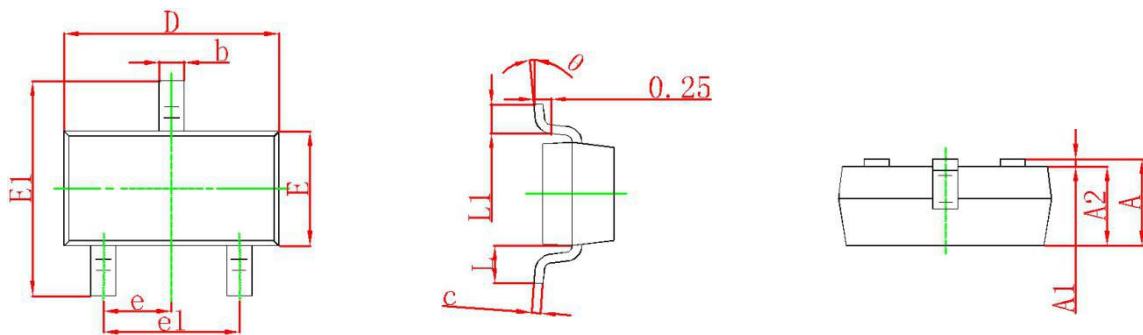


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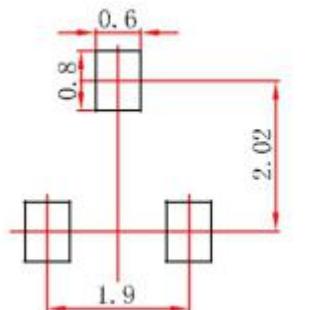
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### SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

### SOT-23 Suggested Pad Layout



Note:  
1. Controlling dimension: in millimeters.  
2. General tolerance:  $\pm 0.05\text{mm}$ .  
3. The pad layout is for reference purposes only.